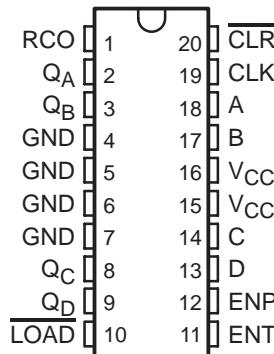


- Internal Look-Ahead for Fast Counting
- Carry Output for n-Bit Cascading
- Fully Synchronous Operation for Counting
- Flow-Through Architecture to Optimize PCB Layout
- Center-Pin V_{CC} and GND Pin Configurations Minimize High-Speed Switching Noise
- EPIC™ (Enhanced-Performance Implanted CMOS) 1- μ m Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline Packages and Standard Plastic 300-mil DIPs

DW OR N PACKAGE
(TOP VIEW)



description

This synchronous, presettable 4-bit decade counter features an internal carry look-ahead circuitry for application in high-speed counting designs. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when so instructed by the count-enable inputs and internal gating. This mode of operation eliminates the output counting spikes that are normally associated with asynchronous (ripple clock) counters; however, counting spikes may occur on the ripple carry out output (RCO). A buffered clock input triggers the four flip-flops on the rising (positive-going) edge of the clock input waveform.

This counter is fully programmable in that they may be preset to any number between 0 and 9. As presetting is synchronous, setting up a low level at the load input disables the counter and causes the outputs to agree with the setup data after the next clock pulse, regardless of the levels of the enable inputs. The clear function for the 74AC11160 is synchronous and a low level at the clear input sets all four of the flip-flops outputs low, regardless of the levels of the clock, load, or enable inputs.

If one of these decade counters is preset to a number between 10 and 15 or assumes such an invalid state when power is applied, it will progress to the normal sequence within two counts as shown in the state diagram.

The carry look-ahead circuitry provides for cascading counters for n-bit synchronous applications without additional gating. Instrumental in accomplishing this function are two count-enable inputs and a ripple carry output. Both count-enable inputs (ENP and ENT) must be high to count, and ENT is fed forward to enable the ripple carry output (RCO). RCO thus enabled will produce a high-level pulse while the count is 9 (HLLH). This high-level overflow ripple carry pulse can be used to enable successive cascaded stages. Transitions at the ENP or ENT are allowed regardless of the level of the clock input.

This counter features a fully independent clock circuit. Changes at control inputs (ENP, ENT, or LOAD) that will modify the operating mode have no effect on the contents of the counter until clocking occurs. The function of the counter (whether enabled, disabled, loading, or counting) will be dictated solely by the conditions meeting the setup and hold times.

The 74AC11160 is characterized for operation from –40°C to 85°C.

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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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TEXAS
INSTRUMENTS

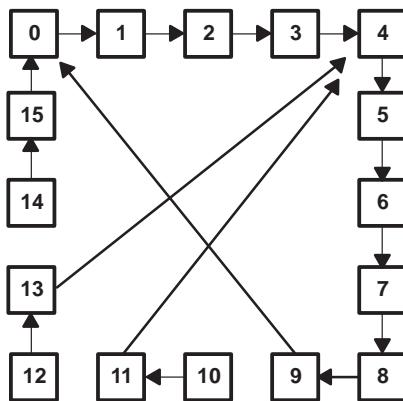
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

74AC11160

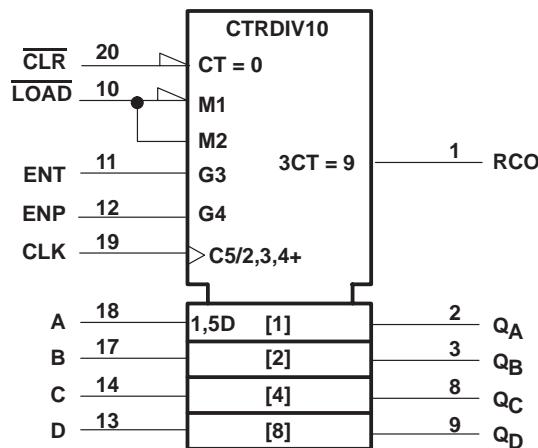
SYNCHRONOUS 4-BIT DECADE COUNTER

SCAS380 -D3199, AUGUST 1988 – REVISED APRIL 1993

state diagram

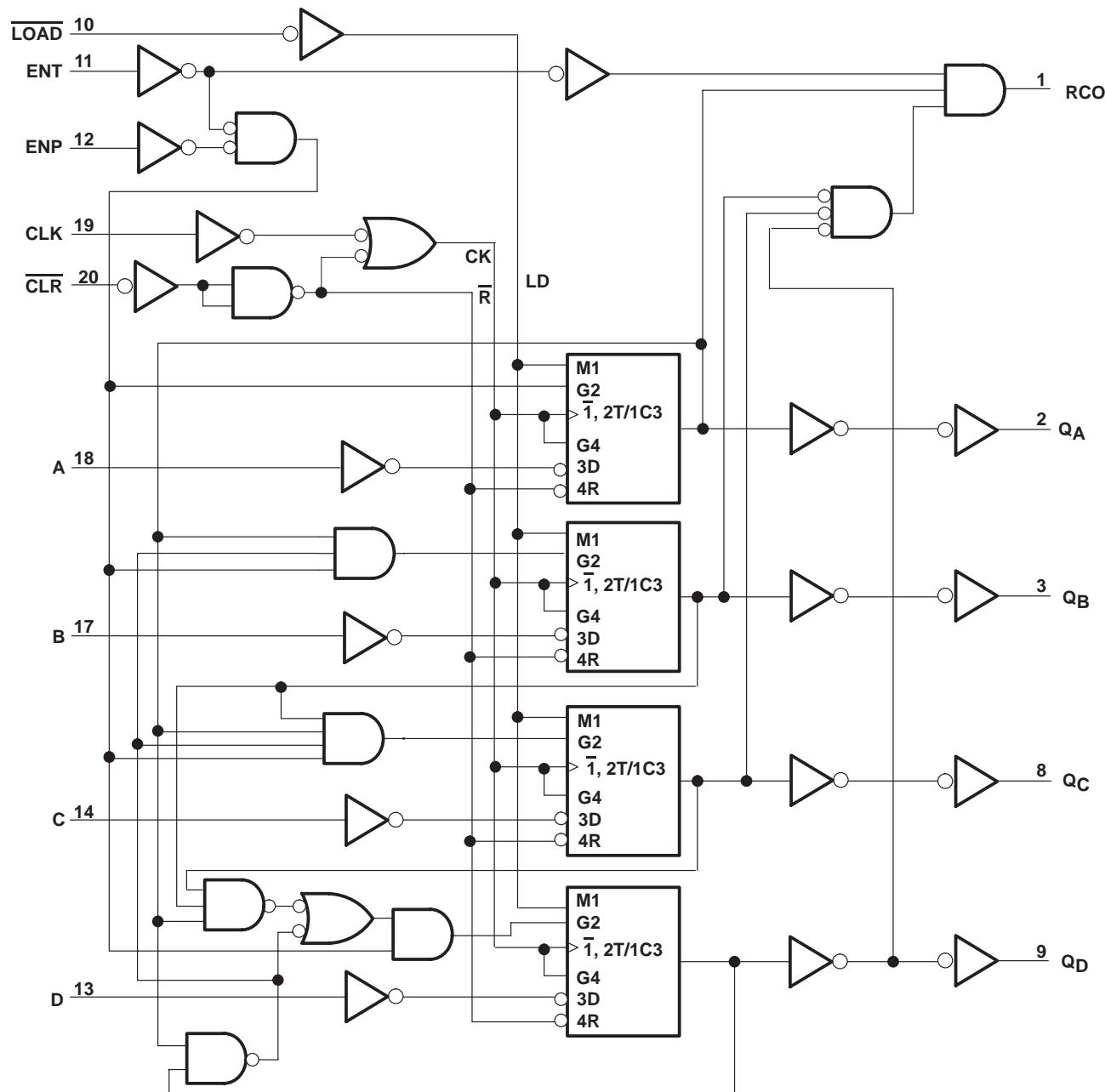


logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

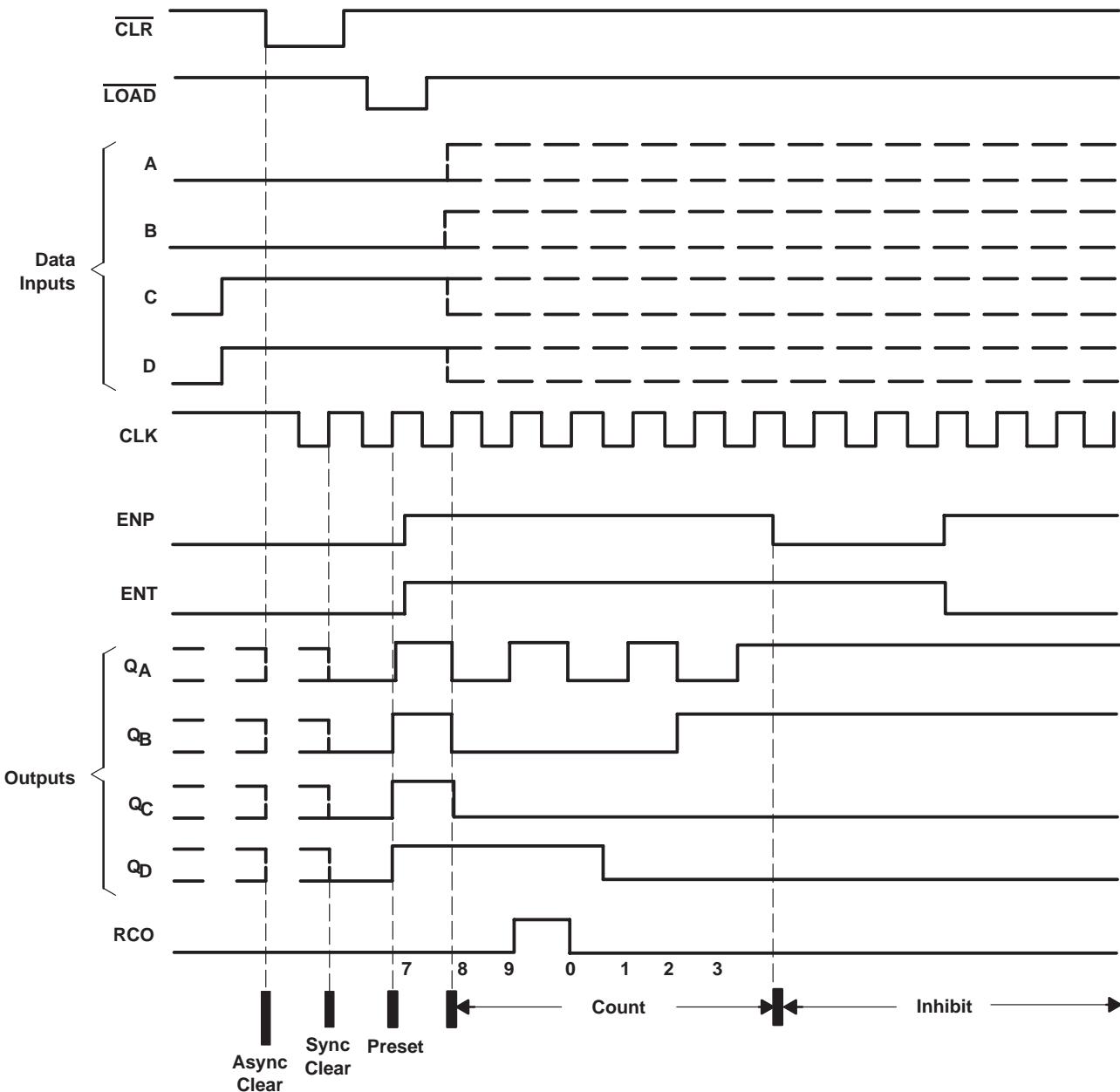
logic diagram (positive logic)[†]



output sequence

Illustrated below is the following sequence:

1. Clear outputs to zero (54AC11160 and 74AC11160 are synchronous)
2. Preset to BCD seven
3. Count to eight, nine, zero, one, two, and three
4. Inhibit.



74AC11160
SYNCHRONOUS 4-BIT DECADE COUNTER

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	-0.5 V to 7 V
Input voltage range, V_I (see Note 1)	-0.5 V to V_{CC} + 0.5 V
Output voltage range, V_O (see Note 1)	-0.5 V to V_{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through V_{CC} or GND pins	±125 mA
Storage temperature range	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

recommended operating conditions (see Note 2)

		MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage	3	5	5.5	V
V_{IH}	High-level input voltage	$V_{CC} = 3$ V	2.1		V
		$V_{CC} = 4.5$ V	3.15		
		$V_{CC} = 5.5$ V	3.85		
V_{IL}	Low-level input voltage	$V_{CC} = 3$ V	0.9		V
		$V_{CC} = 4.5$ V	1.35		
		$V_{CC} = 5.5$ V	1.65		
V_I	Input voltage	0	V_{CC}		V
V_O	Output voltage	0	V_{CC}		V
I_{OH}	High-level output current	$V_{CC} = 3$ V	-4		mA
		$V_{CC} = 4.5$ V	-24		
		$V_{CC} = 5.5$ V	-24		
I_{OL}	Low-level output current	$V_{CC} = 3$ V	12		mA
		$V_{CC} = 4.5$ V	24		
		$V_{CC} = 5.5$ V	24		
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10		ns/V
T_A	Operating free-air temperature	-40	85		°C

NOTE 2: Unused or floating inputs must be held high or low.

74AC11160

SYNCHRONOUS 4-BIT DECADE COUNTER

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	TA = 25°C			MIN	MAX	UNIT
			MIN	TYP	MAX			
V _{OH}	I _{OH} = -50 µA	3 V	2.9		2.9	V		
		4.5 V	4.4		4.4			
		5.5 V	5.4		5.4			
	I _{OH} = -4 mA	3 V	2.58		2.48			
		4.5 V	3.94		3.8			
		5.5 V	4.94		4.8			
	I _{OL} = -24 mA	5.5 V			3.85			
	I _{OH} = -75 mA†	5.5 V						
V _{OL}	I _{OL} = 50 µA	3 V	0.1		0.1	V		
		4.5 V	0.1		0.1			
		5.5 V	0.1		0.1			
	I _{OL} = 12 mA	3 V	0.36		0.44			
		4.5 V	0.36		0.44			
		5.5 V	0.36		0.44			
	I _{OL} = 24 mA	5.5 V			1.65			
	I _{OL} = 75 mA†	5.5 V						
I _I	V _I = V _{CC} or GND	5.5 V		±0.1	±1	µA		
I _{CC}	V _I = V _{CC} or GND, I _O = 0	5.5 V		8	80	µA		
C _i	V _I = V _{CC} or GND	5 V		3.5		pF		

† Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

timing requirements, V_{CC} = 3.3 V ± 0.3 V (see Figure 1)

		TA = 25°C		MIN	MAX	UNIT
		MIN	MAX			
f _{clock}	Clock frequency	0	66	0	66	MHz
t _w	Pulse duration	CLK low or high	7.5	7.5	ns	
		CLR low	6	6		
t _{su}	Setup time before CLK↑	A, B, C, D	6.5	6.5	ns	
		LOAD	6.5	6.5		
		ENT, ENP	6	6		
		CLR inactive	6	6		
t _h	Hold time after CLK↑	1		1		ns

timing requirements, V_{CC} = 5 V ± 0.5 V (see Figure 1)

		TA = 25°C		MIN	MAX	UNIT
		MIN	MAX			
f _{clock}	Clock frequency	0	110	0	110	MHz
t _w	Pulse duration	CLK low or high	4.5	4.5	ns	
		CLR low	4.5	4.5		
t _{su}	Setup time before CLK↑	A, B, C, D	3.5	3.5	ns	
		LOAD	6.5	6.5		
		ENT, ENP	4.5	4.5		
		CLR inactive	6	6		
t _h	Hold time after CLK↑	1		1		ns

74AC11160
SYNCHRONOUS 4-BIT DECADE COUNTER

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**switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			MIN	MAX	UNIT
			MIN	TYP	MAX			
f_{max}			66		66			MHz
t_{PLH}	CLK	RCO	1.5	11.2	13.6	1.5	15.2	ns
t_{PHL}			1.5	12.2	15.1	1.5	17.2	
t_{PLH}	CLK (LOAD high)	Any Q	1.5	9	11.2	1.5	12.5	ns
t_{PHL}			1.5	10.6	13.4	1.5	15.1	
t_{PLH}	CLK (LOAD low)	Any Q	1.5	8.6	10.8	1.5	12.1	ns
t_{PHL}			1.5	10.1	12.8	1.5	14.4	
t_{PLH}	ENT	RCO	1.5	6	7.6	1.5	8.3	ns
t_{PHL}			1.5	6.8	8.9	1.5	9.9	
t_{PLH}	<u>CLR</u>	Any Q	1.5	12	15.2	1.5	17.3	ns
t_{PHL}		RCO	1.5	14.1	17.3	1.5	19.7	

**switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			MIN	MAX	UNIT
			MIN	TYP	MAX			
f_{max}			110		110			MHz
t_{PLH}	CLK	RCO	1.5	7.8	9.5	1.5	10.7	ns
t_{PHL}			1.5	8.5	10.6	1.5	12.1	
t_{PLH}	CLK (LOAD high)	Any Q	1.5	6.3	8	1.5	8.9	ns
t_{PHL}			1.5	7.4	9.8	1.5	11.2	
t_{PLH}	CLK (LOAD low)	Any Q	1.5	6	7.5	1.5	8.4	ns
t_{PHL}			1.5	7.1	9.4	1.5	10.7	
t_{PLH}	ENT	RCO	1.5	4.2	5.5	1.5	6	ns
t_{PHL}			1.5	5	6.7	1.5	7.5	
t_{PLH}	<u>CLR</u>	Any Q	1.5	8.2	10.7	1.5	12.1	ns
t_{PHL}		RCO	1.5	9.9	12.2	1.5	13.8	

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd} Power dissipation capacitance	C _L = 50 pF, f = 1 MHz	48	pF

PARAMETER MEASUREMENT INFORMATION

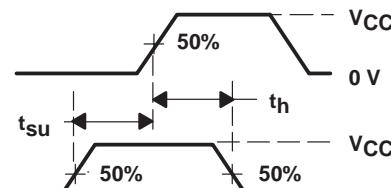
From Output Under Test

 $C_L = 50 \text{ pF}$
(see Note A)

LOAD CIRCUIT

Timing Input
(see Note B)

Data Input



SETUP AND HOLD TIMES

High-Level Input

Low-Level Input

PULSE DURATION

Input
(see Note B)

In-Phase Output

Out-of-Phase Output

V_{CC}

0 V

V_{CC}

0 V

V_{OH}V_{OL}V_{CC}

0 V

V_{CC}

0 V

V_{OH}V_{OL}

PROPAGATION DELAY TIMES

NOTES: A. C_L includes probe and jig capacitance.B. Input pulses are supplied by generators having the following characteristics: PRR $\leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r = 3 \text{ ns}$, $t_f = 3 \text{ ns}$. For testing f_{\max} and pulse duration: $t_r = 1$ to 3 ns , $t_f = 1$ to 3 ns .

C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74AC11160DWR	OBsolete	SOIC	DW	20		TBD	Call TI	Call TI
74AC11160N	OBsolete	PDIP	N	20		TBD	Call TI	Call TI
74AC11160N	OBsolete	PDIP	N	20		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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